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Surface Mount Schottky Power Rectifier

SMA/SMB Power Surface Mount Package

MBRS2H100T3G, NBRS2H100T3G, NBRS2H100NT3G, MBRA2H100T3G, NRVBA2H100T3G, NRVBA2H100T3G,

This device employs the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

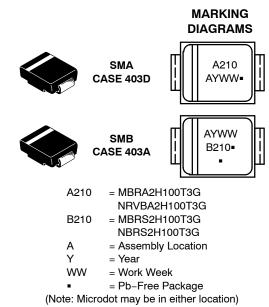
Features

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Overvoltage Protection
- Low Forward Voltage Drop
- NBR and NRVB Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable*

Mechanical Characteristics

- Case: Molded Epoxy
- Epoxy Meets UL 94 V-0 @ 0.125 in
- Weight: 70 mg (SMA), 95 mg (SMB) (Approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- ESD Ratings:
 - Charged Device Model > 1000 V (Class C5)
 - ♦ Human Body Model = 3B
- These Devices are Pb-Free and are RoHS Compliant
- Device Meets MSL1 Requirements





**The Assembly Location code (A) is front side optional. In cases where the Assembly Location is stamped in the package, the front side assembly code may be blank.

ORDERING INFORMATION

Device	Package	Shipping [†]
MBRA2H100T3G, NRVBA2H100T3G*	SMA (Pb-Free)	5,000 / Tape & Reel
MBRS2H100T3G, NBRS2H100T3G* NBRS2H100NT3G*, NBRS2H100T3G-VF01*	SMB (Pb-Free)	2,500 / Tape & Reel
NRVBA2H100NT3G*	SMA (Pb–Free)	5,000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MBRS2H100T3G, NBRS2H100T3G, NBRS2H100NT3G, MBRA2H100T3G, NRVBA2H100T3G, NRVBA2H100NT3G

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	100	V
Average Rectified Forward Current $(T_L = 150^{\circ}C)$	Ι _Ο	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	130	A
Storage Temperature Range	T _{stg}	-65 to +175	°C
Operating Junction Temperature (Note 1)	TJ	-65 to +175	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The heat generated must be less than the thermal conductivity from Junction-to-Ambient: $dP_D/dT_J < 1/R_{\theta JA}$.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Lead (Note 2) MBRA2H100T3G, NRVBA2H100T3G, NRVBA2H100NT3G MBRS2H100T3G, NBRS2H100T3G, NBRS2H100NT3G	Ψ_{JCL}	14 12	°C/W
Thermal Resistance, Junction-to-Ambient (Note 2) MBRA2H100T3G, NRVBA2H100T3G, NRVBA2H100NT3G MBRS2H100T3G, NBRS2H100T3G, NBRS2H100NT3G	R _{θJA}	75 71	°C/W
Thermal Resistance, Junction-to-Ambient (Note 3) MBRA2H100T3G, NRVBA2H100T3G, NRVBA2H100NT3G MBRS2H100T3G, NBRS2H100T3G, NBRS2H100NT3G	R _{0JA}	275 230	°C/W

2. Mounted with 700 mm square copper pad size (Approximately 1 inch square) 1 oz FR4 Board.

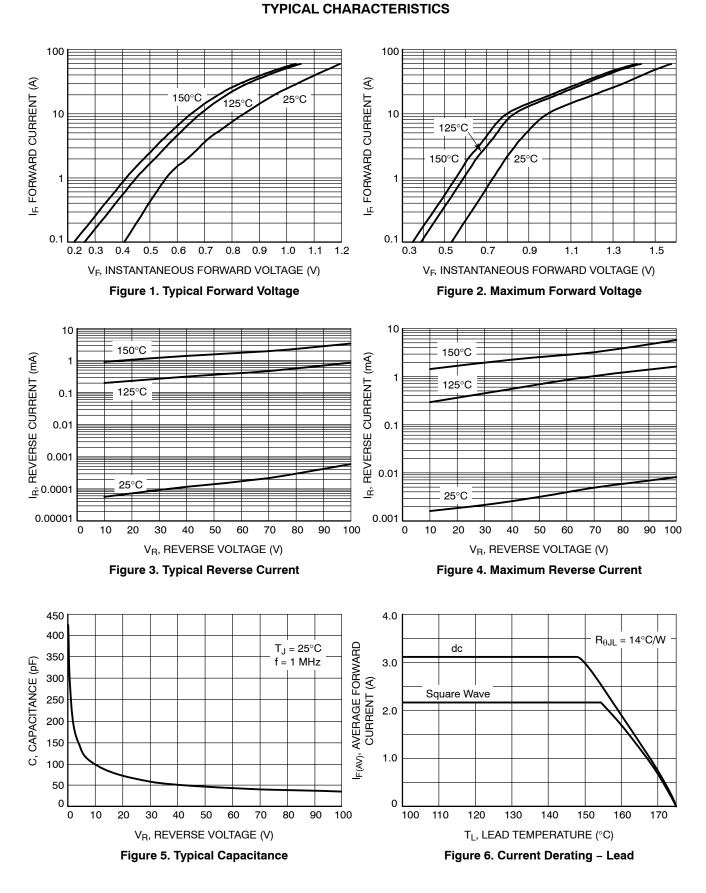
3. Mounted with minimum recommended pad size 1 oz FR4 Board.

ELECTRICAL CHARACTERISTICS

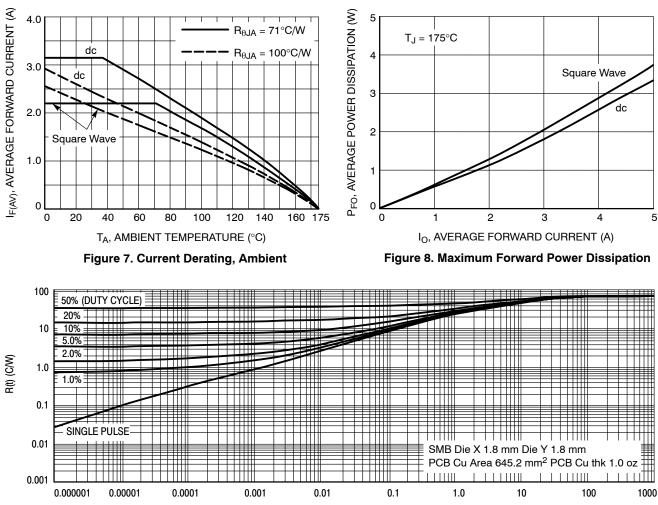
		Value		
Characteristic	Symbol	T _J = 25°C	T _J = 125°C	Unit
Maximum Instantaneous Forward Voltage (Note 4) $(i_F = 2.0 \text{ A})$	VF	0.79	0.65	V
Maximum Instantaneous Reverse Current (Note 4) (V _R = 100 V)	I _R	0.008	1.5	mA

4. Pulse Test: Pulse Width \leq 380 $\mu s,$ Duty Cycle \leq 2.0%.

MBRS2H100T3G, NBRS2H100T3G, NBRS2H100NT3G, MBRA2H100T3G, NRVBA2H100T3G, NRVBA2H100NT3G

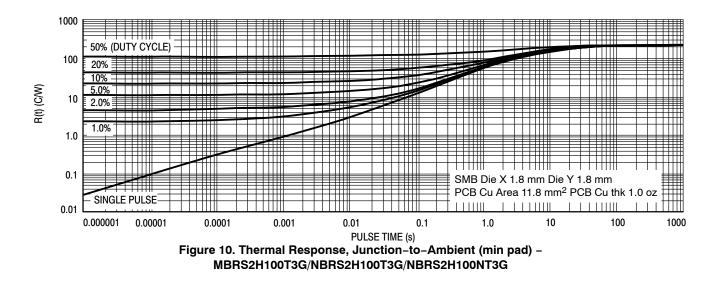


MBRS2H100T3G, NBRS2H100T3G, NBRS2H100NT3G, MBRA2H100T3G, NRVBA2H100T3G, NRVBA2H100NT3G **TYPICAL CHARACTERISTICS**



PULSE TIME (s)

Figure 9. Thermal Response, Junction-to-Ambient (1 inch pad) -MBRS2H100T3G/NBRS2H100T3G/NBRS2H100NT3G



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MBRS2H100T3G, NBRS2H100T3G, NBRS2H100NT3G, MBRA2H100T3G, NRVBA2H100T3G, NRVBA2H100NT3G TYPICAL CHARACTERISTICS

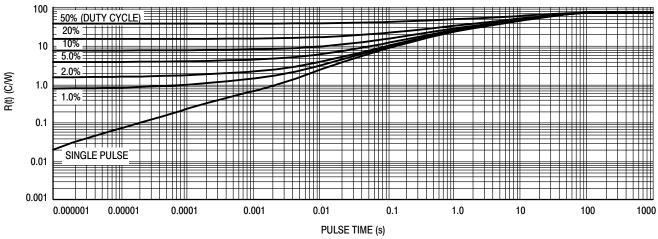


Figure 11. Thermal Response, Junction-to-Ambient (1 inch pad) - MBRA2H100T3G/NRVBA2H100T3G

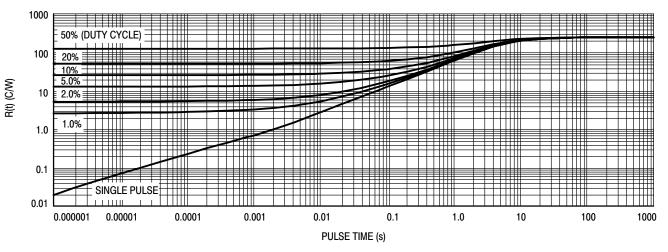


Figure 12. Thermal Response, Junction-to-Ambient (min pad) - MBRA2H100T3G/NRVBA2H100T3G

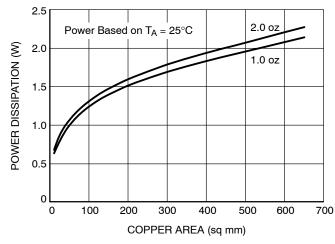
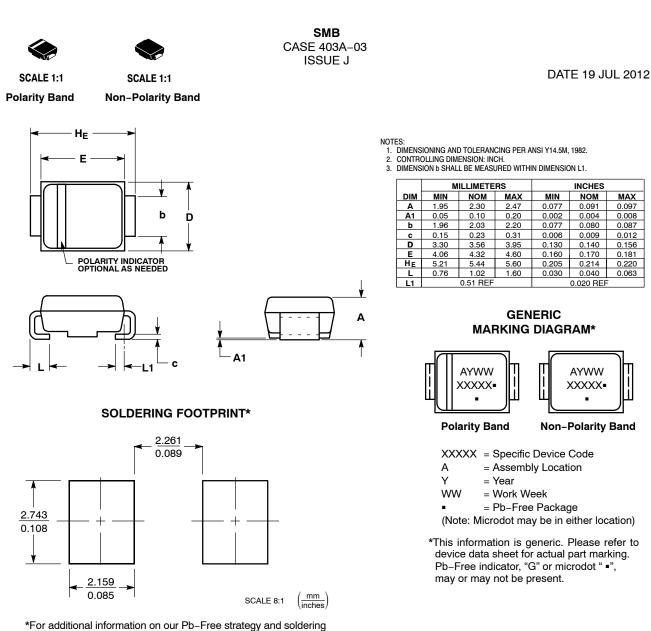


Figure 13. P_D, Junction-to-Ambient (URS copper area)

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

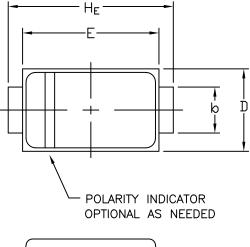
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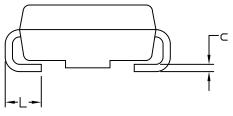
MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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STYLE 1 STYLE 2 SCALE 1:1

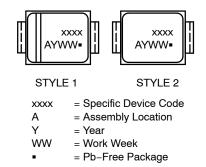




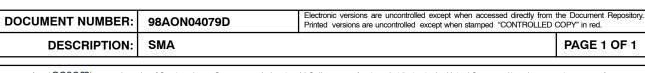


A1

GENERIC **MARKING DIAGRAM***



*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



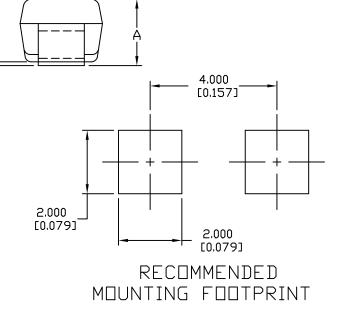
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DATE 22 OCT 2021

NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCHES
- DIMENSION & SHALL BE MEASURED WITHIN DIMENSION L. З.

	MILLIMETERS		INCHES			
DIM	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.
A	1.97	2.10	2.20	0.078	0.083	0.087
A1	0.05	0.10	0.20	0.002	0.004	0.008
Ø	1.27	1.45	1.63	0.050	0.057	0.064
С	0.15	0.28	0.41	0.006	0.011	0.016
D	2.29	2.60	2.92	0.090	0.103	0.115
E	4.06	4.32	4.57	0.160	0.170	0.180
HE	4.83	5.21	5.59	0.190	0.205	0.220
L	0.76	1.14	1.52	0.030	0.045	0.060



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